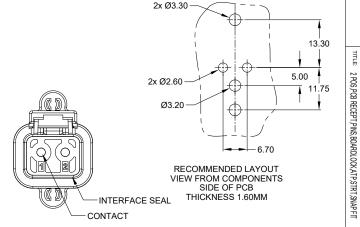
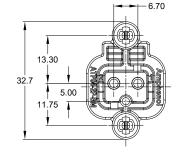


REVISIONS								
REV	ECO	DESCRIPTION	DATE	BY	APPR			
A1	-	RELEASE DRAWING	27/SEP/21	IAN	TOMMY			
A2	-	ADD PRODUCT NUMBER	12/OCT/21	IAN	TOMMY			





NOTES: UNLESS OTHERWISE SPECIFIED

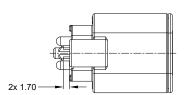
1. MATERIAL: HOUSING: THERMOPLASTIC, BLACK INTERFACE SEAL: SILICONE RUBBER, RED SEAL RETAINER: THERMOPLASTIC, BLACK CONTACT: COPPER ALLOY

- 2. MODIFICATIONS: PCB MOUNT, SNAP FIT
- 3. SPECIFICATIONS:
 - 3.1 CURRENT RATING: 25 AMPS

 - 3.2 OPERATING TEMPERATURE: -55°C TO +125°C 3.3 DIELECTRIC WITHSTANDING VOLTAGE: LESS THAN 2 MILLIAMPS CURRENT LEAKAGE @ 1500 VOLTS AC.
 - 3.4 INSULATION RESISTANCE: 1000 MEGOHMS MIN @ 25°C.
 - 3.5 MOISTURE RESISTANCE:

IP68(IM OF WATER FOR A PERIOD OF 24 HOURS, MATED CONDITION);

- IP69K(MATED CONDITION).
- 3.6 MATING CYCLE DURABILITY: 100 CYCLES
- 3.7 RoHS COMPLIANT
- 4. MATING PART: ATP06-2S* PLUG (* = ALL MODIFICATIONS)
- 5. ALL DIMENSIONS ARE FOR REFERENCE USE ONLY.



ATF	ATP04-2P-BM0X VARIANTS					
CONTACT PLATING	POTTING OR NOT IN RESERVOIR	PART NUMBER				
GOLD	NO POTTING	ATP04-2P-BM01				
GOLD	POTTING	ATP04-2P-BM02				
TIN	NO POTTING	ATP04-2P-BM03				
TIN	POTTING	ATP04-2P-BM04				

									I.
	ATP04-2P-BM0X								\Box
	PART NUMBER			DESCRIPTION			ITEM		
QUANTITY	MATERIALS LIST								
UNLESS OTHERWISE SPECIFIED 1) All dimensions are in metric(mm). 2) Tolerances are as follows: 1 PL DEC ±0.30 2 PL DEC ±0.15 3) Note reference = X			ATURES	S DATE	- Amnnendi		ī		
		DRAWN:	IAN	12/OCT/21			'I		
		CHECKED:	SULLEN	12/OCT/21	Sine Systems - www.amphenol-sine.com				
		ENGINEER:			44724 Morley Drive Clinton Township, MI 48036				
MATERIAL SPECIFICATIONS:		APPROVAL:	TOMMY	13/OCT/21	1,				
PROCESS SPECIFICATIONS: NEXT ASSY:		CUSTOMER: 2 POSITION, PCB MOUNT RECEPTACLE, PINS,							
		SHOWN HEREON ARE THE PROPERTY OF THE AMPHENOL CORPORATION, NO RIGHTS OF REPRODUCTION ARE IMPLIED. ALL DIMENSIONS ARE SUBJECT TO NORMAL		BOARDLOCK, ATP, STRAIGHT, SNAP FIT					
				B	C-	ATP04-2P-	BM0X	A2	
				SCALE: N	ONE		sнеет 1	or 1	